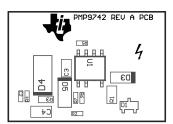


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9742	REV: A	SVN REV:	Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 5/23/2	2014 11:14:06	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9742	REV: A	SVN REV: Not In VersionControl		
	Bottom Overlay <- 390001				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/23/2	2014 11:14:07	AM	TEXAS INSTRUMENTS	

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